

MOSFETs Silicon N-channel MOS (U-MOSIX-H)

TPH1R204PB

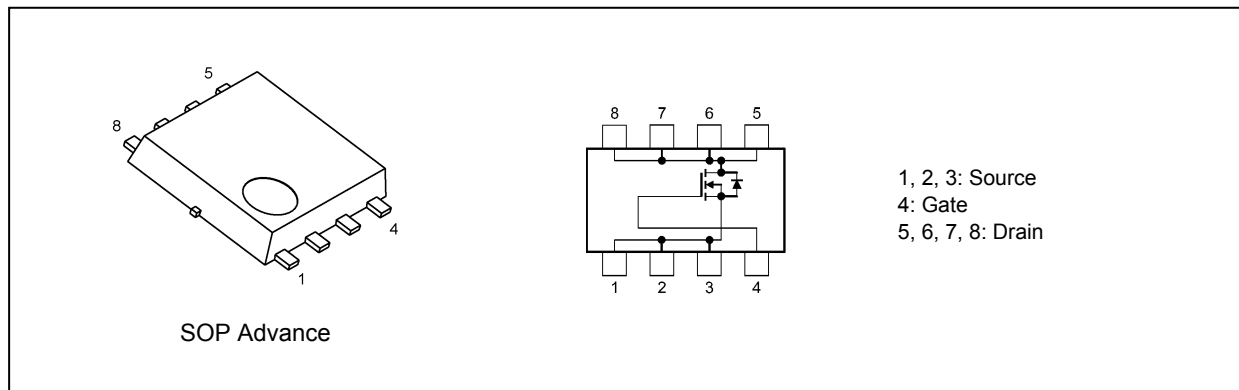
1. Applications

- High-Efficiency DC-DC Converters
- Switching Voltage Regulators
- Motor Drivers

2. Features

- (1) High-speed switching
- (2) Small gate charge: $Q_{SW} = 21 \text{ nC (typ.)}$
- (3) Small output charge: $Q_{OSS} = 56 \text{ nC (typ.)}$
- (4) Low drain-source on-resistance: $R_{DS(ON)} = 0.85 \text{ m}\Omega \text{ (typ.)}$ ($V_{GS} = 10 \text{ V}$)
- (5) Low leakage current: $I_{DSS} = 10 \text{ }\mu\text{A (max)}$ ($V_{DS} = 40 \text{ V}$)
- (6) Enhancement mode: $V_{th} = 2.0 \text{ to } 3.0 \text{ V}$ ($V_{DS} = 10 \text{ V}$, $I_D = 0.5 \text{ mA}$)

3. Packaging and Internal Circuit



Start of commercial production

2017-03

4. Absolute Maximum Ratings (Note) ($T_a = 25\text{ }^{\circ}\text{C}$ unless otherwise specified)

Characteristics	Symbol	Rating	Unit
Drain-source voltage	V_{DS}	40	V
Gate-source voltage	V_{GS}	± 20	
Drain current (DC) ($T_c = 25\text{ }^{\circ}\text{C}$) (Note 1)	I_D	150	A
Drain current (DC) (Silicon limit) (Note 1), (Note 2)	I_D	240	
Drain current (pulsed) ($t = 100\text{ }\mu\text{s}$) (Note 1)	I_{DP}	500	
Power dissipation ($T_c = 25\text{ }^{\circ}\text{C}$)	P_D	132	W
Power dissipation (Note 3)	P_D	3	
Power dissipation (Note 4)	P_D	0.96	
Single-pulse avalanche energy (Note 5)	E_{AS}	80	mJ
Single-pulse avalanche current (Note 5)	I_{AS}	120	A
Channel temperature	T_{ch}	175	$^{\circ}\text{C}$
Storage temperature	T_{stg}	-55 to 175	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

5. Thermal Characteristics

Characteristics	Symbol	Max	Unit
Channel-to-case thermal resistance ($T_c = 25\text{ }^{\circ}\text{C}$)	$R_{th(ch-c)}$	1.13	$^{\circ}\text{C/W}$
Channel-to-ambient thermal resistance ($T_a = 25\text{ }^{\circ}\text{C}$) (Note 3)	$R_{th(ch-a)}$	50	
Channel-to-ambient thermal resistance ($T_a = 25\text{ }^{\circ}\text{C}$) (Note 4)	$R_{th(ch-a)}$	156	

Note 1: Ensure that the channel temperature does not exceed $175\text{ }^{\circ}\text{C}$.

Note 2: Limited 150 A by package capability.

Note 3: Device mounted on a glass-epoxy board (a), Figure 5.1

Note 4: Device mounted on a glass-epoxy board (b), Figure 5.2

Note 5: $V_{DD} = 32\text{ V}$, $T_{ch} = 25\text{ }^{\circ}\text{C}$ (initial), $L = 4.3\text{ }\mu\text{H}$, $I_{AS} = 120\text{ A}$

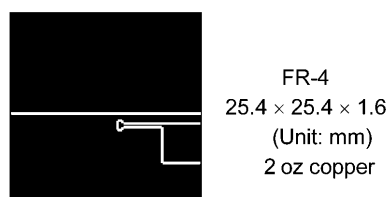


Fig. 5.1 Device Mounted on a Glass-Epoxy Board (a)

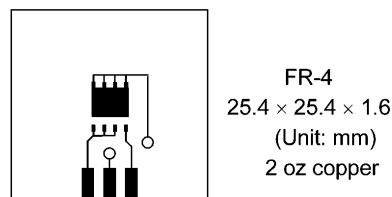


Fig. 5.2 Device Mounted on a Glass-Epoxy Board (b)

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

6. Electrical Characteristics

6.1. Static Characteristics ($T_a = 25^\circ\text{C}$ unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current	I_{GSS}	$V_{GS} = \pm 20\text{ V}, V_{DS} = 0\text{ V}$	—	—	100	nA
Drain cut-off current	I_{DSS}	$V_{DS} = 40\text{ V}, V_{GS} = 0\text{ V}$	—	—	10	μA
Drain-source breakdown voltage	$V_{(BR)DSS}$	$I_D = 10\text{ mA}, V_{GS} = 0\text{ V}$	40	—	—	V
Drain-source breakdown voltage (Note 6)	$V_{(BR)DSX}$	$I_D = 10\text{ mA}, V_{GS} = -20\text{ V}$	20	—	—	
Gate threshold voltage	V_{th}	$V_{DS} = 10\text{ V}, I_D = 0.5\text{ mA}$	2.0	—	3.0	
Drain-source on-resistance	$R_{DS(ON)}$	$V_{GS} = 6\text{ V}, I_D = 50\text{ A}$	—	1.2	1.96	m Ω
		$V_{GS} = 10\text{ V}, I_D = 50\text{ A}$	—	0.85	1.2	

Note 6: If a reverse bias is applied between gate and source, this device enters $V_{(BR)DSX}$ mode. Note that the drain-source breakdown voltage is lowered in this mode.

6.2. Dynamic Characteristics ($T_a = 25^\circ\text{C}$ unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Input capacitance	C_{iss}	$V_{DS} = 20\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$	—	4400	5855	pF
Reverse transfer capacitance	C_{rss}		—	55	105	
Output capacitance	C_{oss}		—	1300	—	
Gate resistance	r_g	—	—	3.0	4.5	Ω
Switching time (rise time)	t_r	See Fig. 6.2.1	—	9	—	ns
Switching time (turn-on time)	t_{on}		—	22	—	
Switching time (fall time)	t_f		—	17	—	
Switching time (turn-off time)	t_{off}		—	61	—	

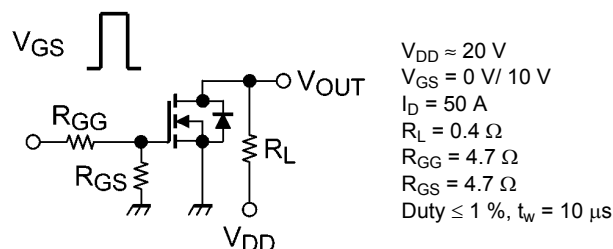


Fig. 6.2.1 Switching Time Test Circuit

6.3. Gate Charge Characteristics ($T_a = 25^\circ\text{C}$ unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Total gate charge (gate-source plus gate-drain)	Q_g	$V_{DD} \approx 20\text{ V}, V_{GS} = 10\text{ V}, I_D = 50\text{ A}$	—	62	—	nC
Gate-source charge 1	Q_{gs1}		—	22	—	
Gate-drain charge	Q_{gd}		—	9.6	—	
Gate switch charge	Q_{SW}		—	21	—	
Output charge	Q_{oss}	$V_{DS} = 20\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$	—	56	—	

6.4. Source-Drain Characteristics (T_a = 25 °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Reverse drain current (pulsed) (Note 7)	I _{DRP}	(t = 100 μs)	—	—	500	A
Diode forward voltage	V _{DSF}	I _{DR} = 150 A, V _{GS} = 0 V	—	—	-1.2	V
Reverse recovery time	t _{rr}	I _{DR} = 37.5 A, V _{GS} = 0 V, -dI _{DR} /dt = 100 A/μs	—	49	—	ns
Reverse recovery charge	Q _{rr}		—	44	—	nC

Note 7: Ensure that the channel temperature does not exceed 175 °C.

7. Marking

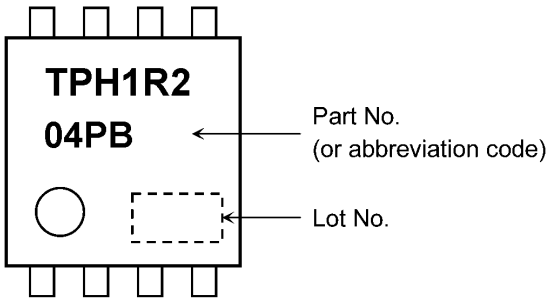


Fig. 7.1 Marking

8. Characteristics Curves (Note)

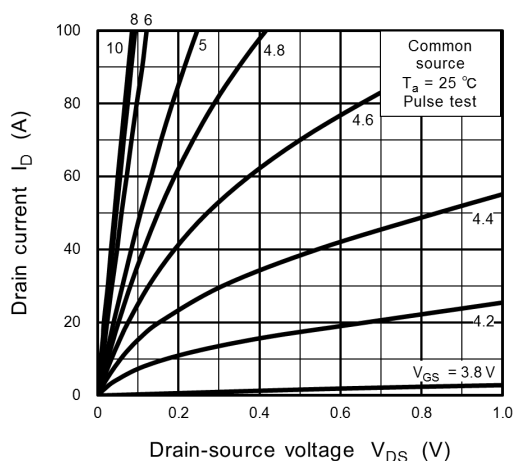


Fig. 8.1 $I_D - V_{DS}$

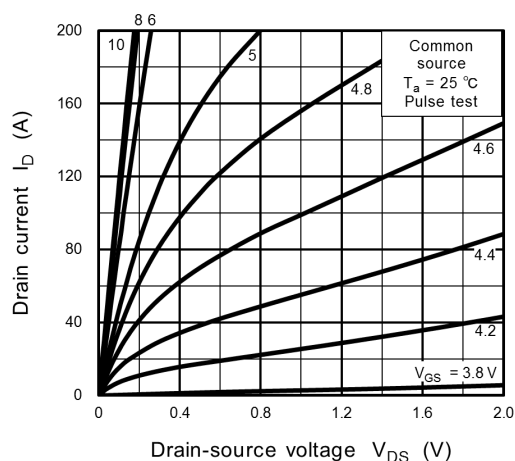


Fig. 8.2 $I_D - V_{DS}$

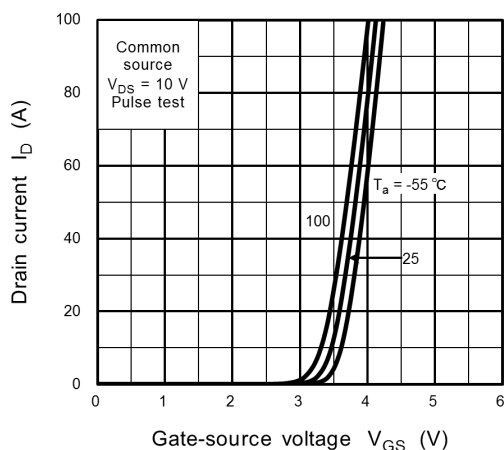


Fig. 8.3 $I_D - V_{GS}$

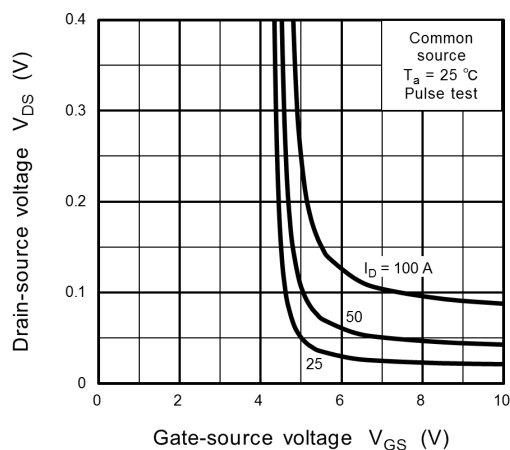


Fig. 8.4 $V_{DS} - V_{GS}$

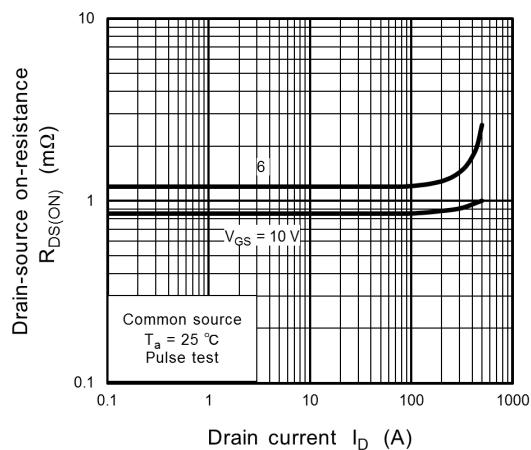


Fig. 8.5 $R_{DS(ON)} - I_D$

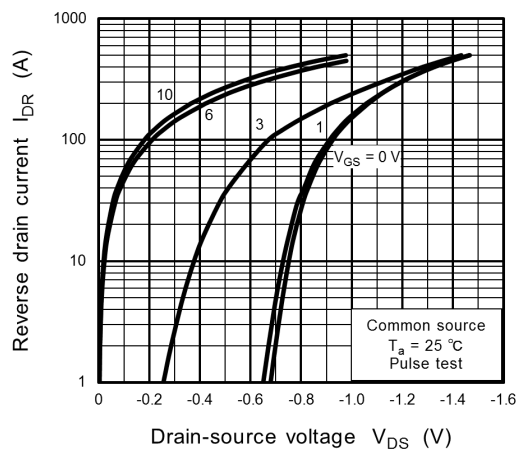


Fig. 8.6 $I_{DR} - V_{DS}$

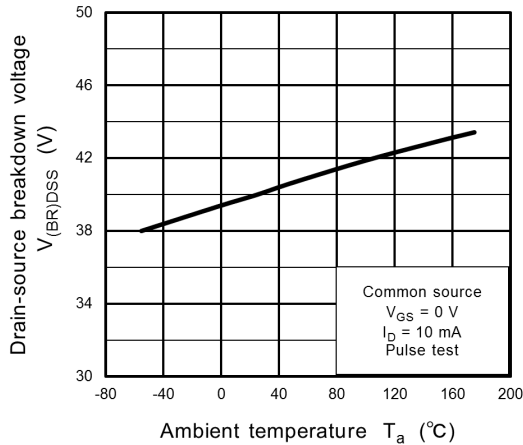


Fig. 8.7 $V_{(BR)DSS} - T_a$

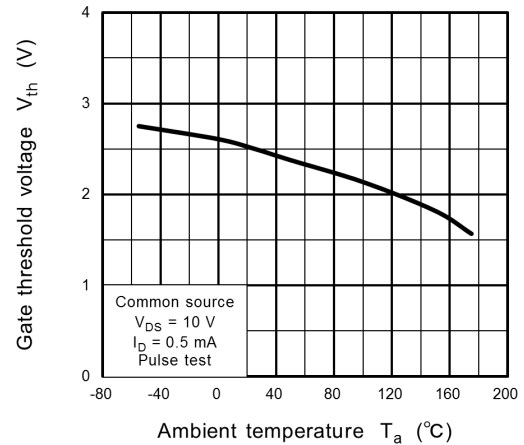


Fig. 8.8 $V_{th} - T_a$

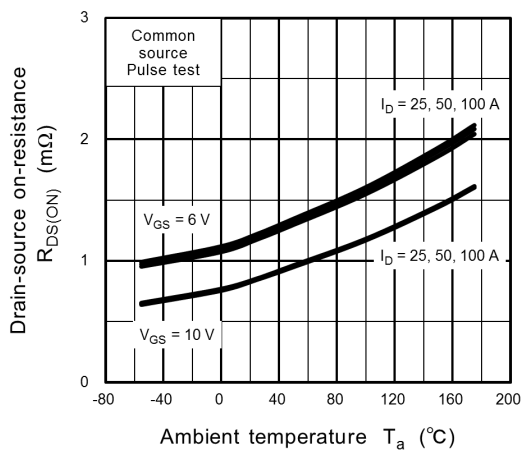


Fig. 8.9 $R_{DS(ON)} - T_a$

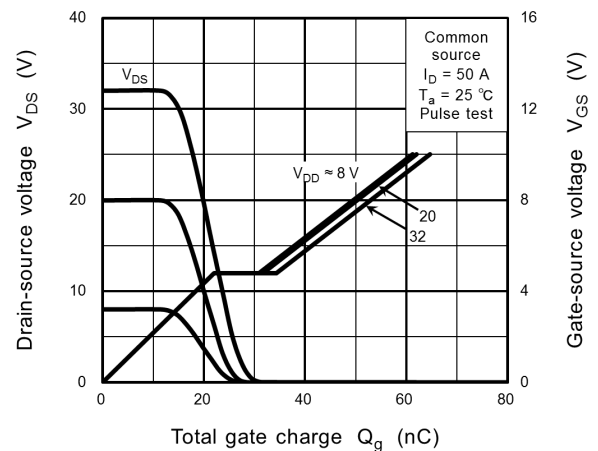


Fig. 8.10 Dynamic Input/Output Characteristics

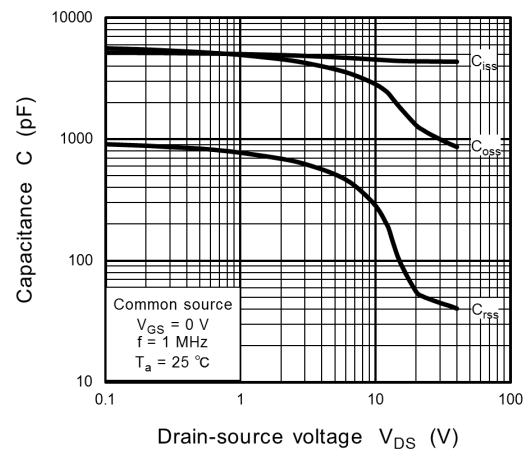


Fig. 8.11 Capacitance - V_{DS}

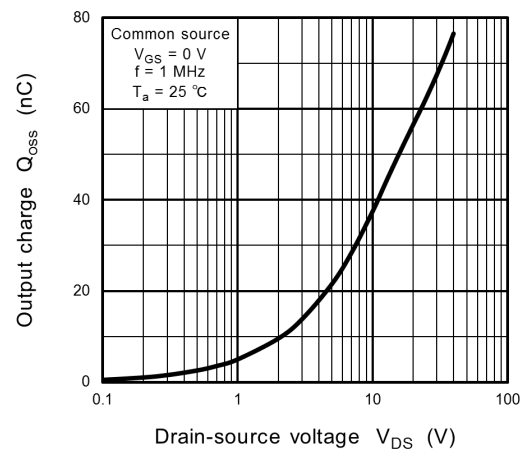


Fig. 8.12 $Q_{oss} - V_{DS}$

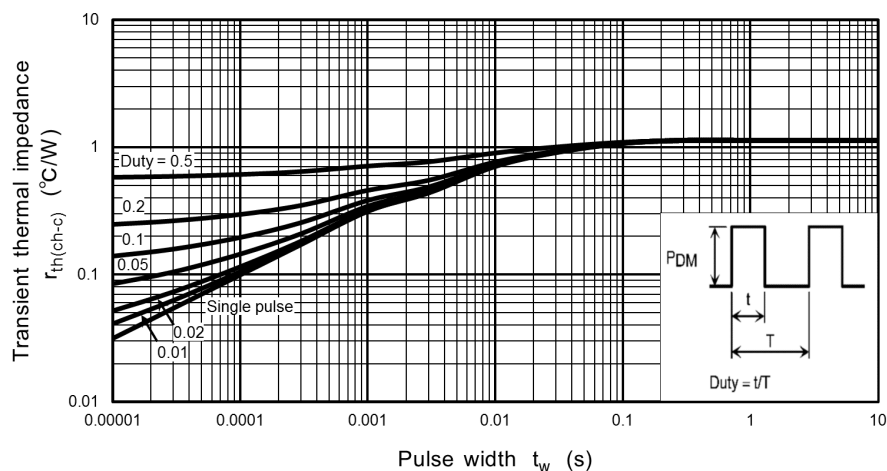


Fig. 8.13 $r_{th} - t_w$
(Guaranteed Maximum)

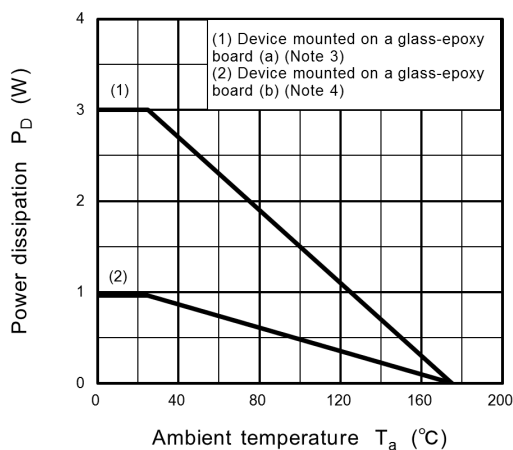


Fig. 8.14 $P_D - T_a$
(Guaranteed Maximum)

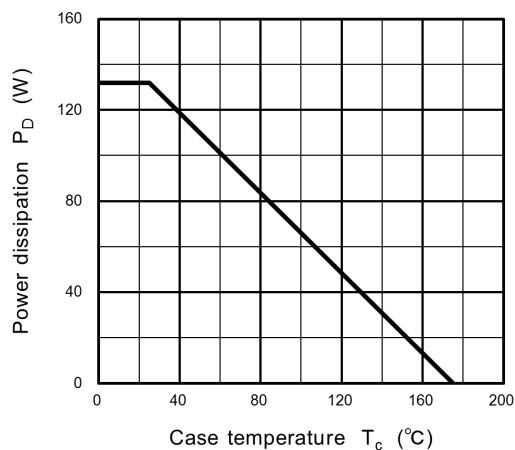


Fig. 8.15 $P_D - T_c$
(Guaranteed Maximum)

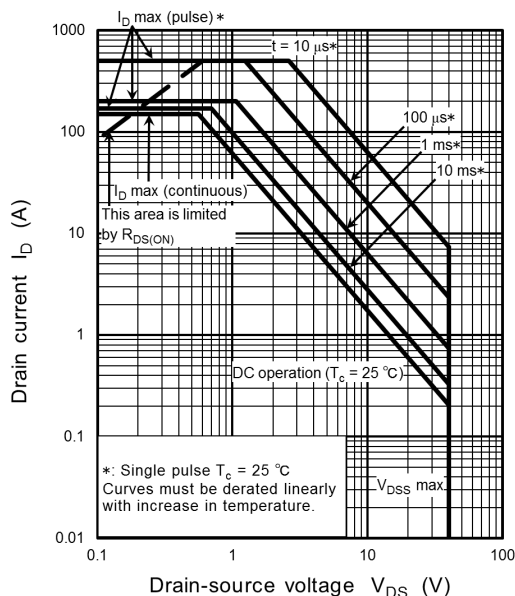
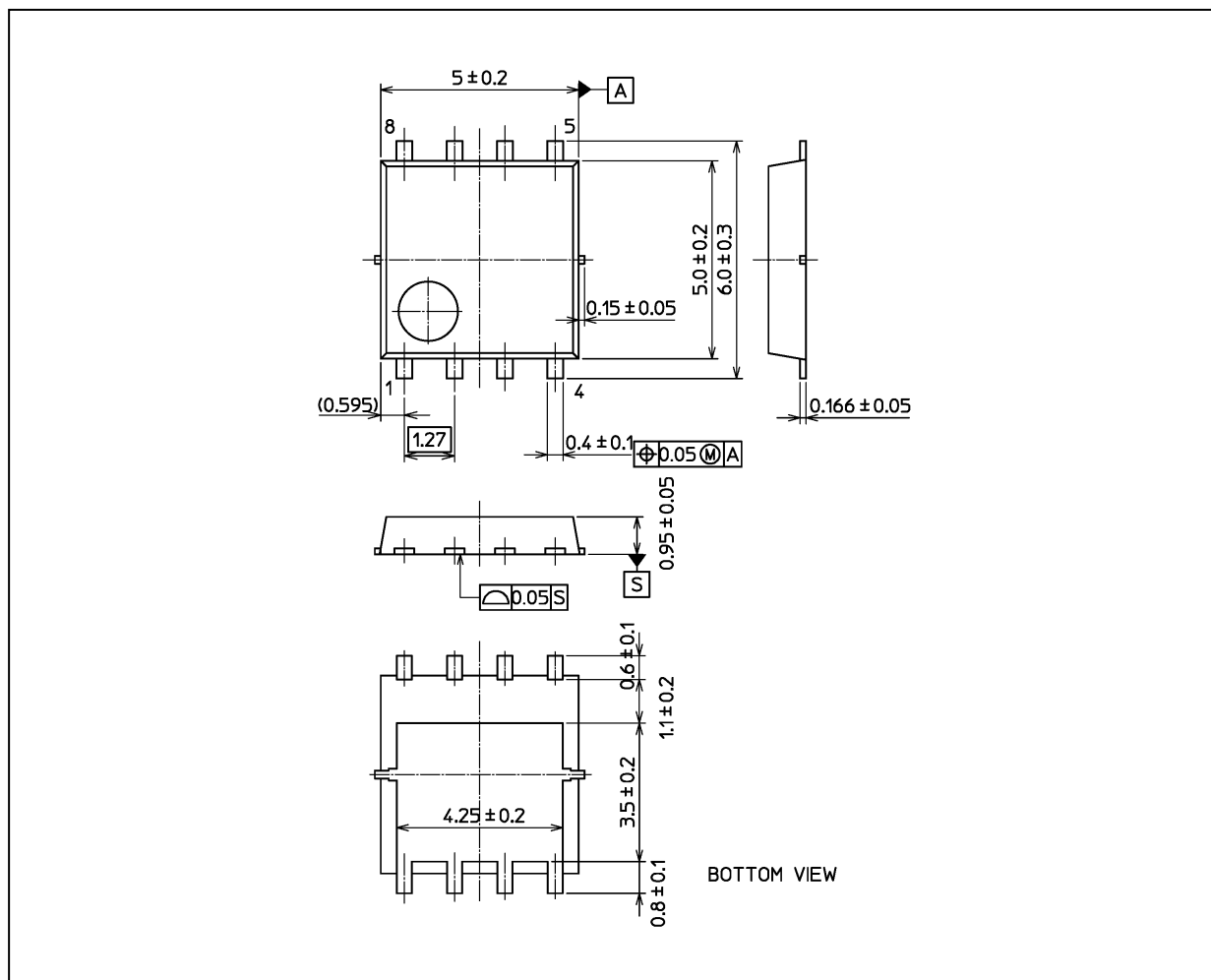


Fig. 8.16 Safe Operating Area
(Guaranteed Maximum)

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

Package Dimensions

Unit: mm



Weight: 0.079 g (typ.)

Package Name(s)
TOSHIBA: 2-5Q1S
Nickname: SOP Advance

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